MM3Z2V4ST1 SERIES

Zener Voltage Regulators

200 mW SOD-323 Surface Mount Tight Tolerance Portfolio

This series of Zener diodes is packaged in a SOD-323 surface mount package that has a power dissipation of 200 mW. They are designed to provide voltage regulation protection and are especially attractive in situations where space is at a premium. They are well suited for applications such as cellular phones, hand-held portables, and high density PC boards.

Specification Features:

- Standard Zener Breakdown Voltage Range 2.4 V to 33 V
- Steady State Power Rating of 200 mW
- Small Body Outline Dimensions: 0.067" x 0.049" (1.7 mm x 1.25 mm)
- Low Body Height: 0.035" (0.9 mm)
- Package Weight: 4.507 mg/unit
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- Tight Tolerance V_Z
- Pb-Free Packages are Available

Mechanical Characteristics:

CASE: Void-free, transfer-molded plastic
FINISH: All external surfaces are corrosion resistant
MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES: 260°C for 10 Seconds
LEADS: Plated with Pb–Sn or Sn only (Pb–Free)
POLARITY: Cathode indicated by polarity band
FLAMMABILITY RATING: UL 94 V–0
MOUNTING POSITION: Any

MAXIMUM RATINGS

| Rating | Symbol | Мах | Unit |
|---|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR-5 Board, (Note 1) @ T _A = 25°C Derate above 25°C | P _D | 200 1.5 | mW mW/°C |
| Thermal Resistance from Junction-to-Ambient | $R_{\theta JA}$ | 635 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | -65 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

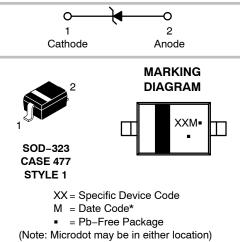
1. FR-4 Minimum Pad.

Downloaded from Elcodis.com electronic components distributor



ON Semiconductor®

http://onsemi.com



*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------|----------------------|-----------------------|
| MM3ZxxxST1 | SOD-323 | 3000/Tape & Reel |
| MM3ZxxxST1G | SOD-323 (Pb-Free) | 3000/Tape & Reel |
| MM3ZxxxST3 | SOD-323 | 10,000/Tape & Reel |
| MM3ZxxxST3G | SOD-323 (Pb-Free) | 10,000/Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

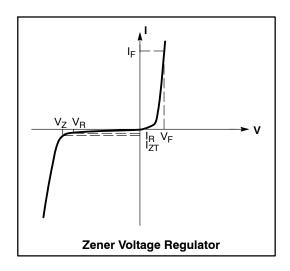
DEVICE MARKING INFORMATION

See specific marking information in the device marking column of the Electrical Characteristics table on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted}, V_F = 0.9 V Max. @ I_F = 10 mA for all types)$

| Symbol | Parameter |
|-----------------|---|
| VZ | Reverse Zener Voltage @ I _{ZT} |
| I _{ZT} | Reverse Current |
| Z _{ZT} | Maximum Zener Impedance @ I _{ZT} |
| I _{ZK} | Reverse Current |
| Z _{ZK} | Maximum Zener Impedance @ I _{ZK} |
| I _R | Reverse Leakage Current @ V _R |
| V _R | Reverse Voltage |
| ١ _F | Forward Current |
| V _F | Forward Voltage @ I _F |
| ΘV_Z | Maximum Temperature Coefficient of V_Z |
| С | Max. Capacitance $@V_R = 0$ and f = 1 MHz |



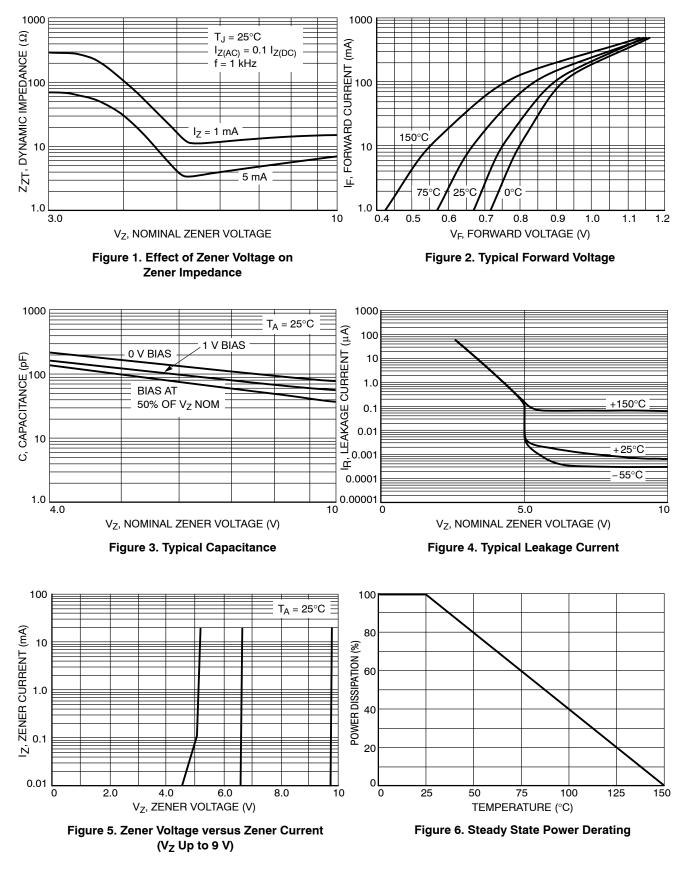
ELECTRICAL CHARACTERISTICS (V_F = 0.9 Max @ I_F = 10 mA for all types)

| | | Test | Zener Voltage VZ | | Z _{ZK} I _Z = 0.5 | Z _{ZT} I _Z = IZT @ 10% | | Max IR @ VR | | (mV/k) = 5 mA | C pF Max @ |
|---------------|-------------------|-------------------|------------------|-------|---|--|------|----------------|------|------------------|---------------------------------|
| Device* | Device Marking | Current Izt mA | Min | Мах | mA Ω Max | Mod Ω Max | μA | v | Min | Max | V _R = 0 f = 1 MHz |
| MM3Z3V3ST1, G | T5 | 5.0 | 3.32 | 3.53 | 1000 | 95 | 5.0 | 1.0 | -3.5 | 0 | 450 |
| MM3Z3V9ST1, G | T7 | 5.0 | 3.89 | 4.16 | 1000 | 90 | 3.0 | 1.0 | -3.5 | -2.5 | 450 |
| MM3Z4V3ST1, G | T8 | 5.0 | 4.17 | 4.43 | 1000 | 90 | 3.0 | 1.0 | -3.5 | 0 | 450 |
| MM3Z4V7ST1, G | Т9 | 5.0 | 4.55 | 4.75 | 800 | 80 | 3.0 | 2.0 | -3.5 | 0.2 | 260 |
| MM3Z5V1ST1, G | TA | 5.0 | 4.98 | 5.2 | 500 | 60 | 2.0 | 2.0 | -2.7 | 1.2 | 225 |
| MM3Z5V6ST1, G | TC | 5.0 | 5.49 | 5.73 | 200 | 40 | 1.0 | 2.0 | -2.0 | 2.5 | 200 |
| MM3Z6V2ST1, G | TE | 5.0 | 6.06 | 6.33 | 100 | 10 | 3.0 | 4.0 | 0.4 | 3.7 | 185 |
| MM3Z6V8ST1, G | TF | 5.0 | 6.65 | 6.93 | 160 | 15 | 2.0 | 4.0 | 1.2 | 4.5 | 155 |
| MM3Z7V5ST1, G | TG | 5.0 | 7.28 | 7.6 | 160 | 15 | 1.0 | 5.0 | 2.5 | 5.3 | 140 |
| MM3Z8V2ST1, G | TH | 5.0 | 8.02 | 8.36 | 160 | 15 | 0.7 | 5.0 | 3.2 | 6.2 | 135 |
| MM3Z9V1ST1, G | ТК | 5.0 | 8.85 | 9.23 | 160 | 15 | 0.5 | 6.0 | 3.8 | 7.0 | 130 |
| MM3Z10VST1, G | WB | 5.0 | 9.80 | 10.20 | 160 | 15 | 0.5 | 6.0 | 4.5 | 8.0 | 130 |
| MM3Z12VST1, G | TN | 5.0 | 11.74 | 12.24 | 80 | 25 | 0.1 | 8.0 | 6.0 | 10 | 130 |
| MM3Z15VST1, G | TP | 5.0 | 14.34 | 14.98 | 80 | 40 | 0.1 | 11 | 8.8 | 12.7 | 130 |
| MM3Z16VST1, G | TU | 5.0 | 15.85 | 16.51 | 80 | 40 | 0.05 | 11.2 | 10.4 | 14 | 105 |
| MM3Z18VST1, G | TW | 5.0 | 17.56 | 18.35 | 80 | 45 | 0.05 | 12.6 | 12.4 | 16 | 100 |
| MM3Z22VST1G | WP | 5.0 | 21.54 | 22.47 | 100 | 55 | 0.05 | 15.4 | 16.4 | 20 | 85 |
| MM3Z27VST1G | WQ | 5.0 | 26.19 | 27.53 | 300 | 80 | 0.05 | 18.9 | 21.4 | 25.3 | 70 |
| MM3Z33VST1G | WR | 5.0 | 32.15 | 33.79 | 300 | 80 | 0.05 | 23.2 | 27.4 | 33.4 | 70 |

*The "G" suffix indicates Pb-Free package available.

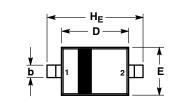
MM3Z2V4ST1 SERIES

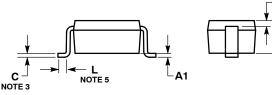
TYPICAL CHARACTERISTICS



PACKAGE DIMENSIONS

SOD-323 CASE 477-02 ISSUE G





NOTES

1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETERS. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING. З.

DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. DIMENSION L IS MEASURED FROM END OF

5. RADIUS.

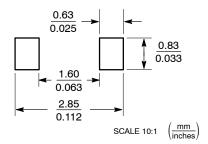
| | MIL | LIMETE | ERS | INCHES | | | | |
|-----|----------|--------|-------|-----------|-------|-------|--|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | | |
| Α | 0.80 | 0.90 | 1.00 | 0.031 | 0.035 | 0.040 | | |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 | | |
| A3 | 0.15 REF | | | 0.006 REF | | | | |
| b | 0.25 | 0.32 | 0.4 | 0.010 | 0.012 | 0.016 | | |
| С | 0.089 | 0.12 | 0.177 | 0.003 | 0.005 | 0.007 | | |
| D | 1.60 | 1.70 | 1.80 | 0.062 | 0.066 | 0.070 | | |
| Е | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 | | |
| L | 0.08 | | | 0.003 | | | | |
| HE | 2.30 | 2.50 | 2.70 | 0.090 | 0.098 | 0.105 | | |

STYLE 1: PIN 1. CATHODE

2 ANODE

SOLDERING FOOTPRINT*

A3



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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